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PTO FORM 4/92 Page 1 of 1 FORM-PTO-1449 **ATTY. DOCKET 10936-38** SERIAL NO. 09/462,214 LIST OF PATENTS AND PUBLICATIONS APPLICANT Junji Kodemura et al FOR APPLICANT'S INFORMATION FILING DATE **GROUP** January 4, 2000 1734 DISCLOSURE STATEMENT FOR Adhesive for Semiconductor Part UNITED STATES LETTERS PATENT DOCUMENT NUMBER DATE NAME 2 3 5 3 Jun. 15, 1999 McIntosh, III et al aa FOREIGN PATENT DOCUMENTS DOCUMENT NUMBER DATE COUNTRY **CLASS SUB CLASS** 0 0 Dec. 3, 1986 2 Europe 0 2 7 2 0 Jul. 1, 1987 Europe wo 97 2 0 8 7 Jun. 12, 1997 **PCT** n 2000 OCT QTHER ART (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.) Derwent Abstract AN 1991-278329 of JP 3-185013 (1991) DATE CONSIDERED